



ON Semiconductor®

FGD2736G3-F085

EcoSPARK™ 3 270mJ, 360V, N-Channel Ignition IGBT

Features

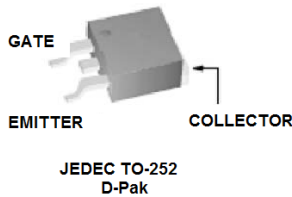
- SCIS Energy = 270mJ at $T_J = 25^\circ\text{C}$
- SCIS Energy = 170mJ at $T_J = 150^\circ\text{C}$
- Logic Level Gate Drive
- RoHS Compliant



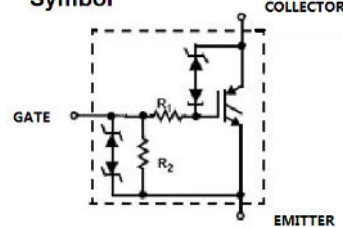
Applications

- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications

Package



Symbol



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Ratings	Units
BV_{CER}	Collector to Emitter Breakdown Voltage ($I_C = 1\text{mA}$)		360	V
BV_{ECS}	Emitter to Collector Voltage - Reverse Battery Condition ($I_C = 10\text{mA}$)		28	V
$ESCIS_{25}$	$I_{SCIS} = 13.4\text{A}$, $L = 3.0\text{mH}$, $R_{GE} = 1\text{K}\Omega$	$T_C = 25^\circ\text{C}$	270	mJ
$ESCIS_{150}$	$I_{SCIS} = 10.8\text{A}$, $L = 3.0\text{mH}$, $R_{GE} = 1\text{K}\Omega$	$T_C = 150^\circ\text{C}$	170	mJ
I_{C25}	Collector Current Continuous, at $T_C = 25^\circ\text{C}$, $V_{GE} = 5.0\text{V}$		21	A
I_{C110}	Collector Current Continuous, at $T_C = 110^\circ\text{C}$, $V_{GE} = 5.0\text{V}$		18	A
V_{GEM}	Gate to Emitter Voltage Continuous		± 10	V
P_D	Power Dissipation Total	$T_C = 25^\circ\text{C}$	150	W
	Power Dissipation Derating	$T_C > 25^\circ\text{C}$	1	W/ $^\circ\text{C}$
T_J	Operating Junction Temperature Range		-40 to +175	$^\circ\text{C}$
T_{STG}	Storage Junction Temperature Range		-40 to +175	$^\circ\text{C}$
T_L	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)		300	$^\circ\text{C}$
T_{PKG}	Max Lead Temp for soldering (Package Body for 10s)		260	$^\circ\text{C}$
ESD	Electrostatic Discharge Voltage at 100pF, 1500Ω		4	kV

FGD2736G3-F085 EcoSPARK™ 270mJ, 360V, N-Channel Ignition IGBT

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	1	°C/W
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Electrical Characteristics of the IGBT $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV_{CER}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{CE} = 2mA,$ $R_{GE} = 1K\Omega,$ $T_J = -40 \text{ to } 150^\circ\text{C}$	330	-	390	V	
BV_{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{CE} = 10mA,$ $R_{GE} = 0\Omega,$ $T_J = -40 \text{ to } 150^\circ\text{C}$	350	-	410	V	
BV_{ECS}	Emitter to Collector Breakdown Voltage	$V_{GE} = 0V, I_{CE} = -75mA,$ $T_J = 25^\circ\text{C}$	28	-	-	V	
BV_{GES}	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 5mA$	± 11	± 14	-	V	
I_{CER}	Collector to Emitter Leakage Current	$V_{CE} = 250V, R_{GE} = 1K\Omega$	$T_J = 25^\circ\text{C}$	-	-	25	μA
			$T_J = 150^\circ\text{C}$	-	-	1	mA
I_{ECS}	Emitter to Collector Leakage Current	$V_{EC} = 24V$	$T_J = 25^\circ\text{C}$	-	-	1	mA
			$T_J = 150^\circ\text{C}$	-	-	40	
R_1	Series Gate Resistance		-	110	-	Ω	
R_2	Gate to Emitter Resistance		10K	-	30K	Ω	

On Characteristics

$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$V_{GE} = 4V, I_{CE} = 6A$	$T_J = 25^\circ\text{C}$	-	1.25	1.35	V
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$V_{GE} = 4.5V, I_{CE} = 10A$	$T_J = 25^\circ\text{C}$	-	1.45	1.65	V
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage		$T_J = 150^\circ\text{C}$		1.6	1.8	V

Dynamic Characteristics

$Q_{G(ON)}$	Gate Charge	$V_{GE} = 5V, V_{CE} = 12V, I_{CE} = 10A$	-	18	-	nC	
$V_{GE(TH)}$	Gate to Emitter Threshold Voltage	$I_{CE} = 1mA, V_{CE} = V_{GE},$	$T_J = 25^\circ\text{C}$	1.3	1.6	2.2	V
			$T_J = 150^\circ\text{C}$	0.75	1.1	1.8	
V_{GEP}	Gate to Emitter Plateau Voltage	$V_{CE} = 12V, I_{CE} = 10A$	-	3.0	-	V	

Switching Characteristics

$t_{d(ON)R}$	Current Turn-On Delay Time-Resistive	$V_{CE} = 14V, R_L = 1\Omega$	-	0.9	4	μs
t_{rR}	Current Rise Time-Resistive	$V_{GE} = 5V, R_G = 1K\Omega$	-	3	7	μs
$t_{d(OFF)L}$	Current Turn-Off Delay Time-Inductive	$V_{CE} = 300V, L = 2mH,$	-	4.4	15	μs
t_{fL}	Current Fall Time-Inductive	$V_{GE} = 5V, R_G = 1K\Omega$	-	1.9	15	μs

Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGD2736G3	FGD2736G3-F085	TO-252AA	330mm	16mm	2500units

Typical Performance Curves

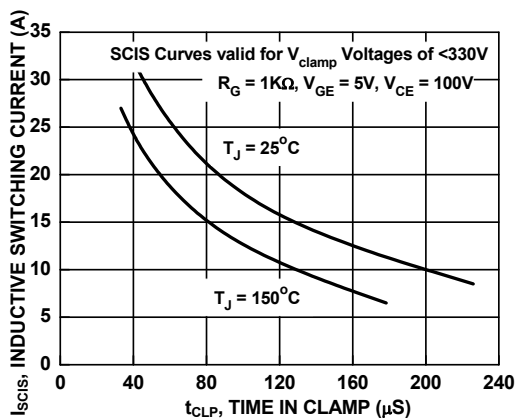


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp

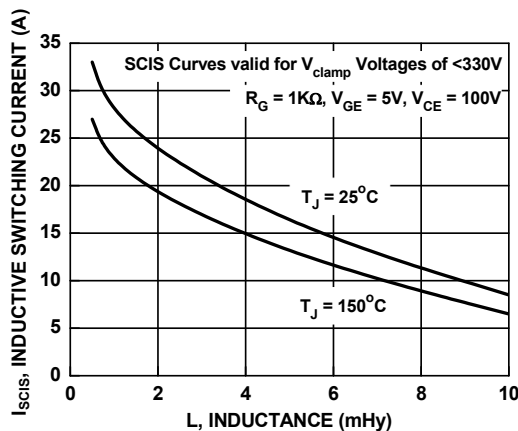


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

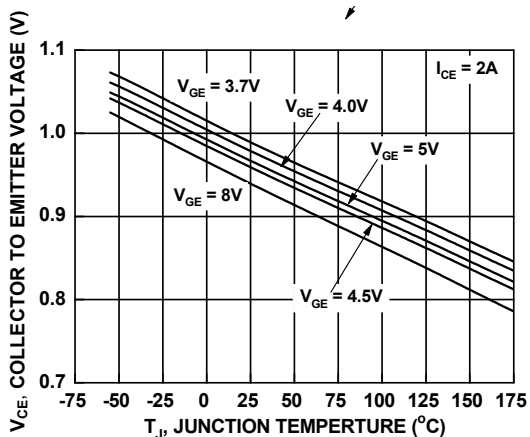


Figure 3. Collector to Emitter On-State Voltage vs. Junction Temperature

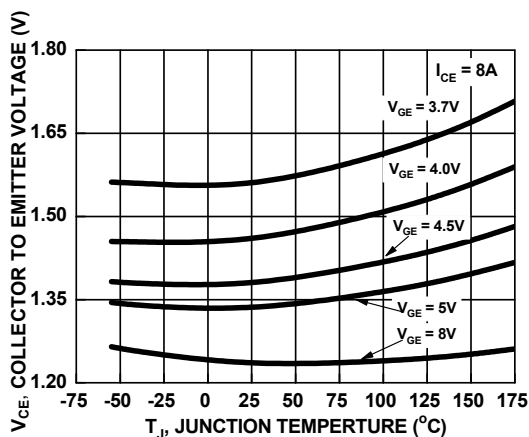


Figure 4. Collector to Emitter On-State Voltage vs. Junction Temperature

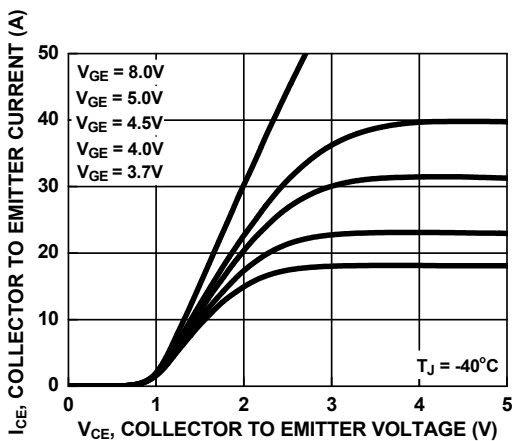


Figure 5. Collector to Emitter On-State Voltage vs. Collector Current

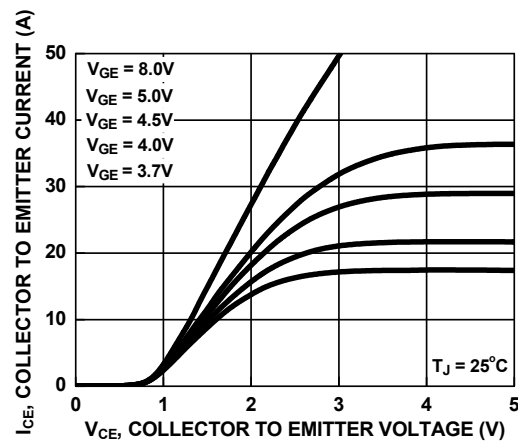


Figure 6. Collector to Emitter On-State Voltage vs. Collector Current

Typical Performance Curves (Continued)

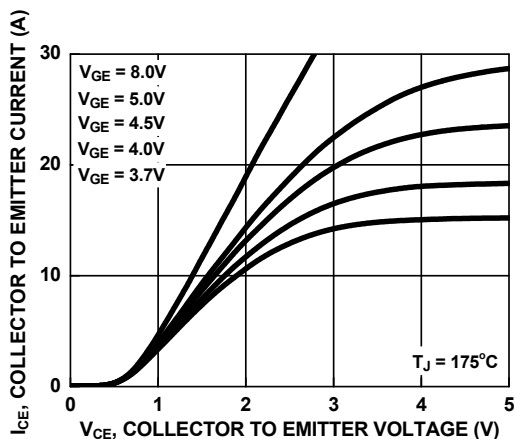


Figure 7. Collector to Emitter On-State Voltage vs. Collector Current

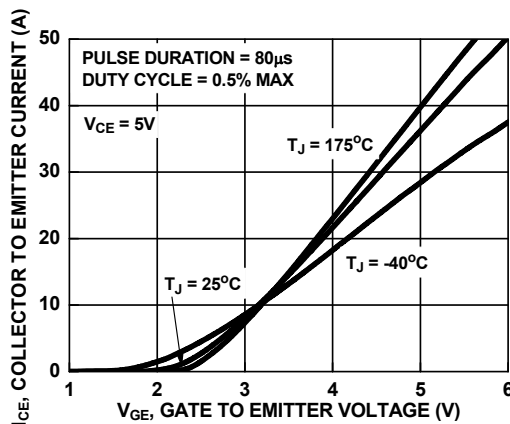


Figure 8. Transfer Characteristics

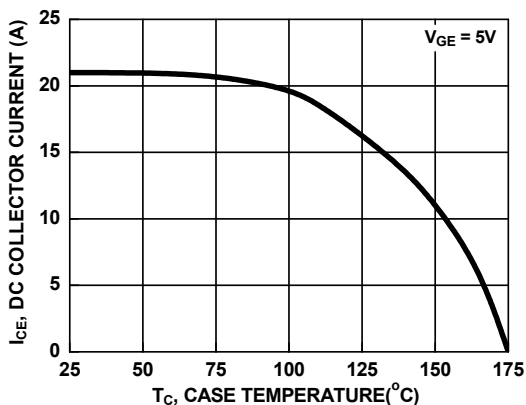


Figure 9. DC Collector Current vs. Case Temperature

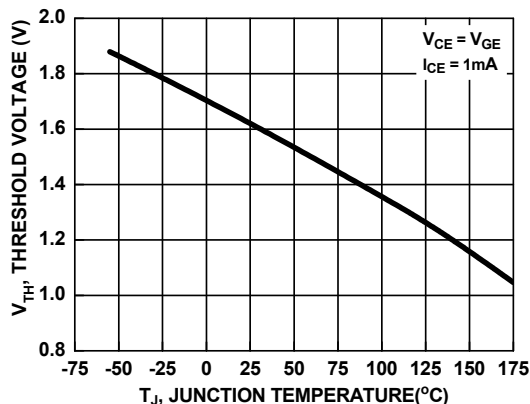


Figure 10. Threshold Voltage vs. Junction Temperature

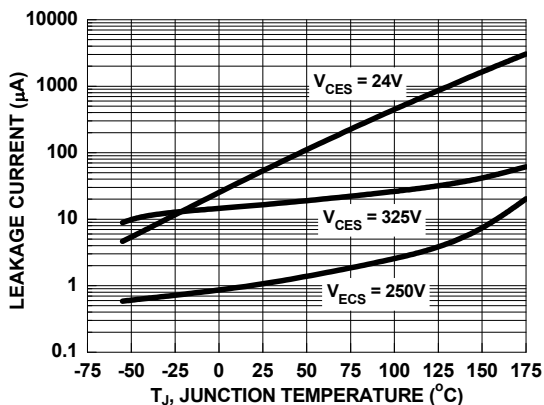


Figure 11. Leakage Current vs. Junction Temperature

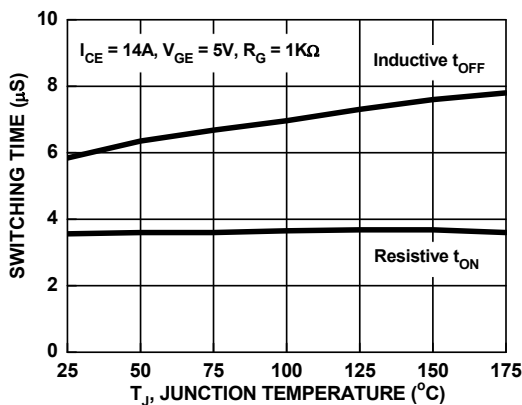


Figure 12. Switching Time vs. Junction Temperature

Typical Performance Curves (Continued)

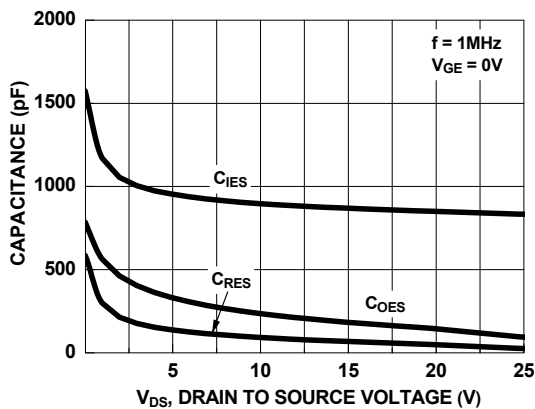


Figure 13. Capacitance vs. Collector to Emitter Voltage

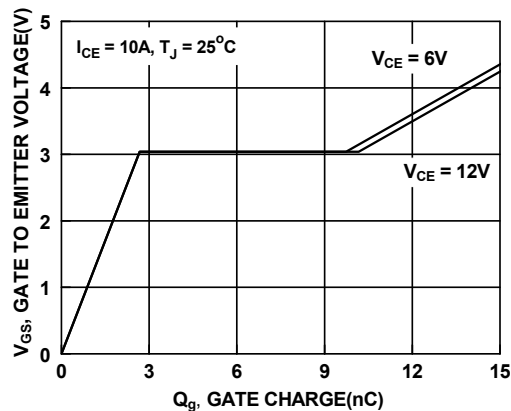


Figure 14. Gate Charge

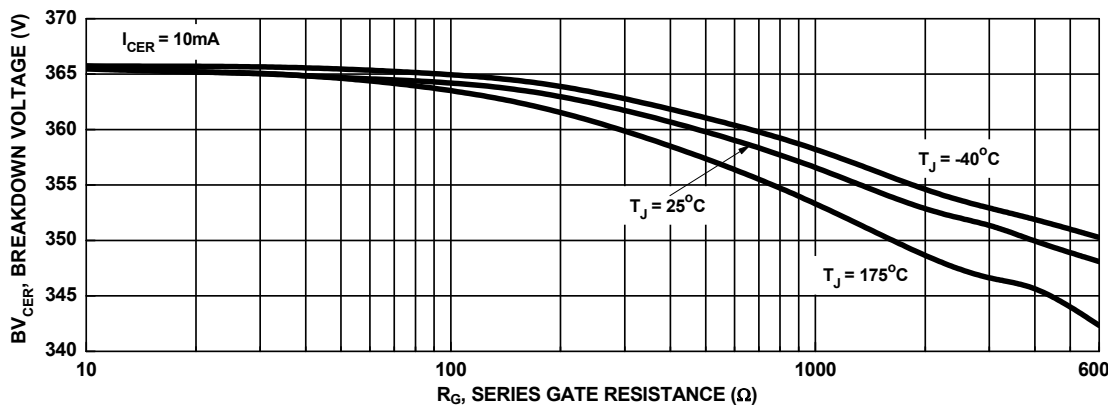


Figure 15. Break down Voltage vs. Series Gate Resistance

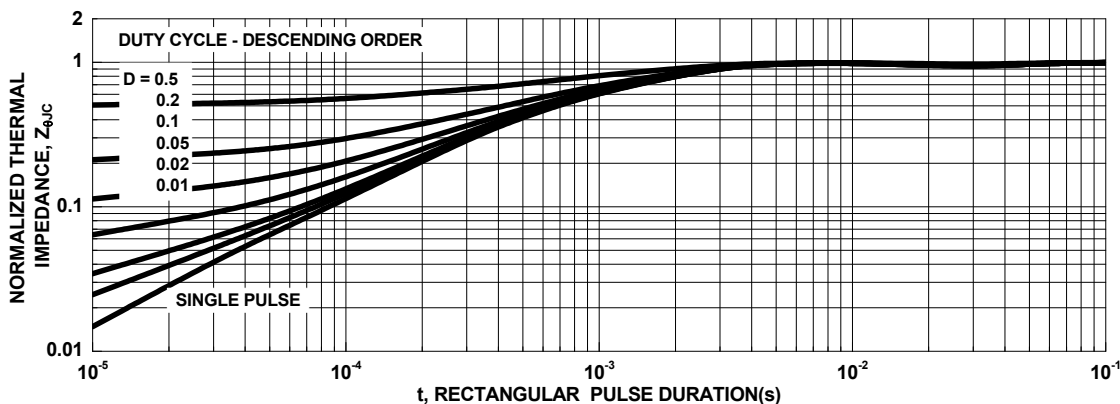


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

Typical Performance Curves

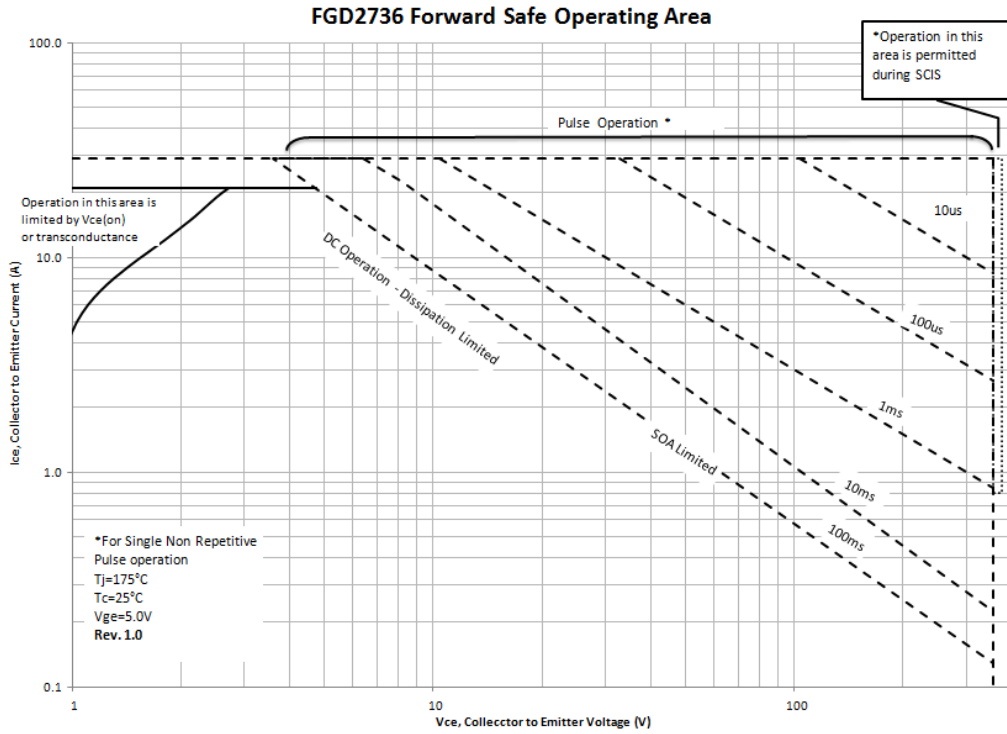
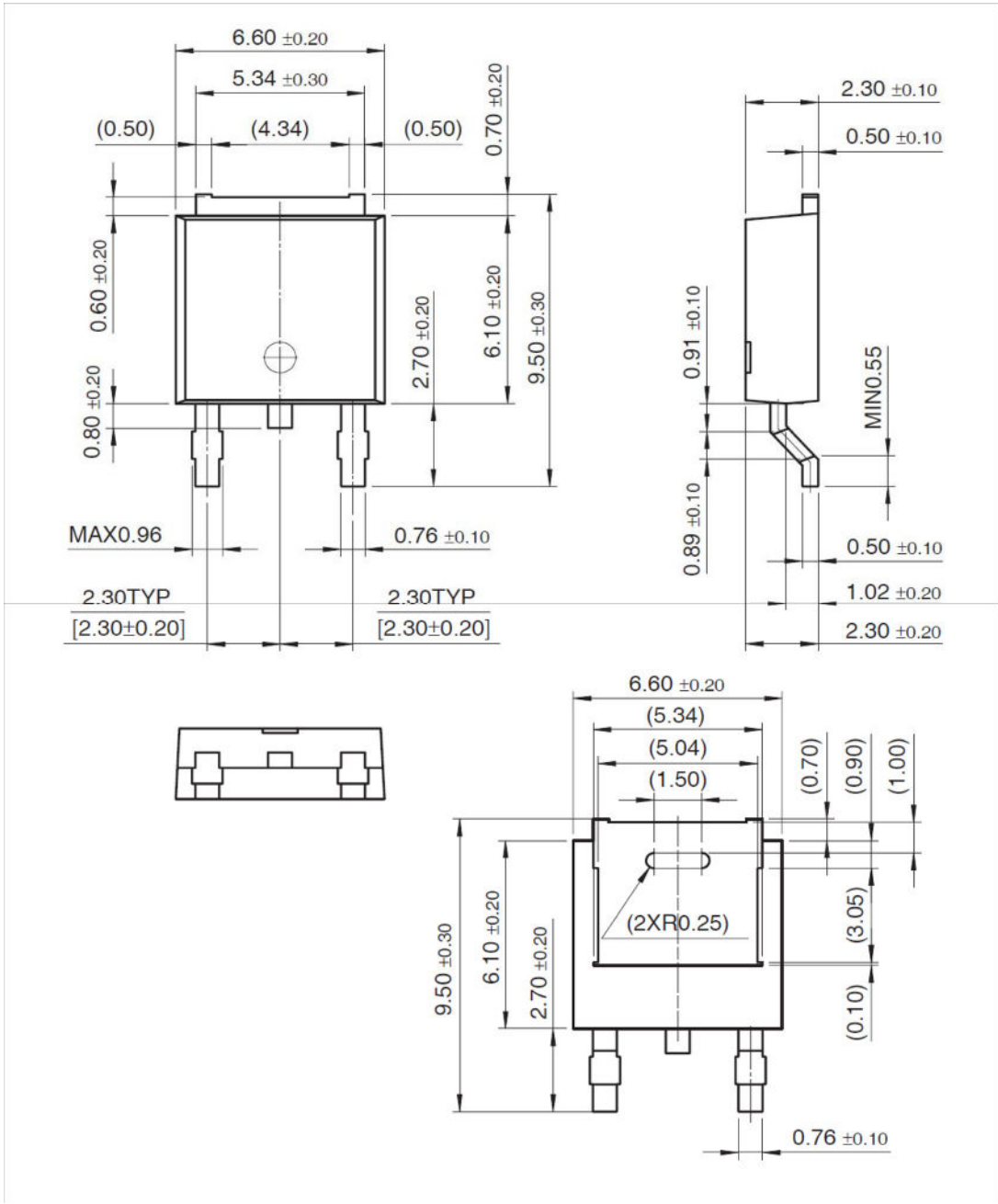



Figure 17. Forward Safe Operating Area

FGD2736G3-F085 EcoSPARK™ 270mJ, 360V, N-Channel Ignition IGBT

Physical Dimensions



FGD2736G3-F085 EcoSPARK™ 270mJ, 360V, N-Channel Ignition IGBT

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